

2.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

Glass Passivated Die Construction Super-Fast Recovery Time For High Efficiency Surge Overload Rating to 50A Peak

Ideally Suited for Automated Assembly

Lead Free Finish/RoHS Compliant (Note 4)

Mechanical Data

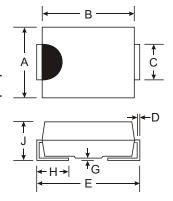
Case: SMB

Case Material: Molded Plastic. UL Flammability

Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 @3 Polarity: Cathode Band or Cathode Notch

Marking Information: See Page 3 Ordering Information: See Page 3 Weight: 0.093 grams (approximate)



SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
С	1.96	2.21		
D	0.15	0.31		
E	5.00	5.59		
G	0.10	0.20		
Н	0.76	1.52		
J	2.00	2.62		
All Dimensions in mm				

Maximum Ratings and Electrical Characteristics @ TA = 25 C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 5)	V _{RRM} V _{RWM} V _R	400	V
RMS Reverse Voltage	V _{R(RMS)}	280	V
Average Rectified Output Current @ T _T = 110 C	Io	2.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	50	Α
Forward Voltage @ I _F = 2.0A	V _{FM}	1.25	V
Peak Reverse Current @ T _A = 25 C at Rated DC Blocking Voltage (Note 5) @ T _A = 125 C	I _{RM}	5.0 350	Α
Reverse Recovery Time (Note 3)	t _{rr}	35	ns
Typical Capacitance (Note 2)	Ст	25	pF
Typical Thermal Resistance, Junction to Terminal (Note 1)		20	°C/W
Operating and Storage Temperature Range		-55 to +150	С

Notes:

- 1. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{rr} = 0.25A$. See Figure 5.
- 4. RoHS revision 13.2.2003. Glass and high temperature solder exemptions applied, see EU Directive Annex Notes 5 and 7.
- 5. Short duration pulse test used to minimize self-heating effect



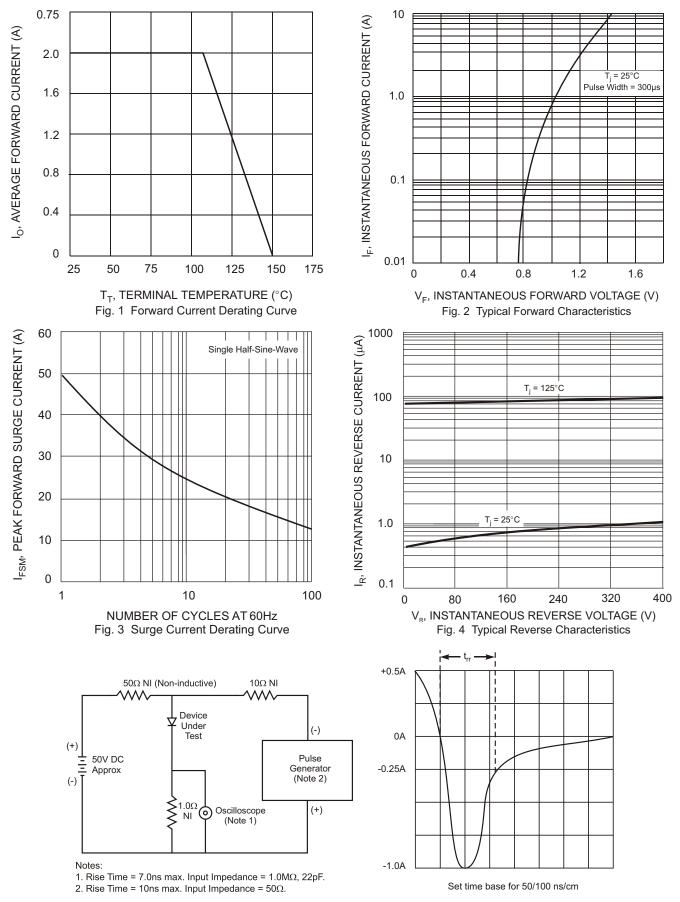


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



Ordering Information (Note 6)

Device	Packaging	Shipping
ES2G-13-F	SMB	5000/Tape & Reel

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



ES2G = Product type marking code
J!! = Manufacturers' code marking
YWW = Date code marking
Y = Last digit of year ex: 2 for 2002
WW = Week code 01 to 52

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